MAX6575L/H

SOT Temperature Sensor with Multidrop Single-Wire Digital Interface

General Description

The MAX6575L/H is a low-cost, low-current temperature sensor with a single-wire digital interface. It features accuracy of $\pm 3^{\circ}$ C at $+25^{\circ}$ C, $\pm 4.5^{\circ}$ C at $+85^{\circ}$ C, and $\pm 5^{\circ}$ C at $+125^{\circ}$ C. The MAX6575L/H is a monostable, externally triggered temperature sensor that allows a microproces sor (μ P) to interface with up to eight temperature sensors using a single control line. Temperatures are sensed by measuring the time delay between the falling edge of the external triggering pulse and the falling edge of the subsequent pulse delays reported from the devices. Different sensors on the same I/O line use different timeout multipliers to avoid overlapping signals.

The MAX6575L/H features eight different timeout multipliers; these are selectable by using the two time-select pins on each device and choosing the "L" or "H" version. The "L" version provides four delay ranges less than 50ms. The "H" version provides four delay ranges greater than 50ms. The MAX6575L/H is available in a space-saving 6-pin SOT23 package.

Applications

- Critical µP and µC Temperature Monitoring
- Portable Battery-Powered Equipment
- Cell Phones
- Battery Packs
- Hard Drives/Tape Drives
- Networking and Telecom Equipment
- Medical Equipment

Features

- Simple Single-Wire Interface to μP or μC
- Multidrop up to Eight Sensors on One Wire
- ±0.8°C Accuracy at +25°C (±3°C max)
- Operates from +2.7V to +5.5V Supply Voltage
- Low 150µA (typ) Supply Current
- Standard Operating Temperature Range -40°C to +125°C
- Small 6-Pin SOT23 Package

Ordering Information

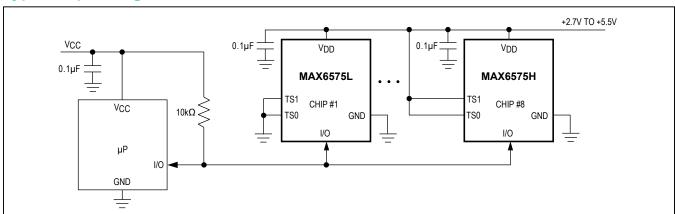
| PART | TEMP.RANGE | PIN- PACKAGE | SOT TOP MARK |
|-------------|-----------------|-----------------|-----------------|
| MAX6575LZUT | -40°C to +125°C | 6 SOT23 | AABG |
| MAX6575HZUT | -40°C to +125°C | 6 SOT23 | AABH |

Selector Guide

| PART | TIMEOUT MULTIPLIERS (µs/°K) |
|----------|-----------------------------|
| MAX6575L | 5, 20, 40, 80 |
| MAX6575H | 160, 320, 480, 640 |

Pin Configuration appears at end of data sheet.

Typical Operating Circuit





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Absolute Maximum Ratings

| Terminal Voltage (with respect to GND) | | Continuous Power Dissipation ($T_A = +70^{\circ}C$) | |
|--|----------------------------------|---|----------------|
| V _{DD} | 0.3V to +6V | 6-Pin SOT23 (derate 7.10mW/°C above +70 |)°C)571mW |
| TS1, TS0 | 0.3V to (V _{DD} + 0.3V) | Operating Temperature Range | 40°C to +125°C |
| I/O | 0.3V to +6V | Storage Temperature Range | 65°C to +150°C |
| Input/Output Current, All Pins | ±20mA | Lead Temperature (soldering, 10s) | +300°C |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect

Electrical Characteristics

 $(V_{DD}$ = +2.7V to +5.5V, T_A = -40°C to +125°C, unless otherwise noted. Typical values are specified at T_A = +25°C and V_{DD} = +5V, unless otherwise noted.)

| PARAMETER | SYMBOL | CONDITIONS | | MIN | TYP | MAX | UNITS | |
|--|--------------------|---|---|------|------|------|-----------|--|
| V _{DD} Range | V_{DD} | | | 2.7 | | 5.5 | V | |
| Cumply Cumpant | 1 | \/ - F F\/ | $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$ | | 150 | 250 | | |
| Supply Current | I _{DD} | $V_{DD} = 5.5V$ | $T_A = -40^{\circ}C \text{ to } +125^{\circ}C$ | | | 400 | μA | |
| | | T _A = -20°C | | -7.5 | ±1.1 | +7.5 | | |
| Townserture Concer France | | $T_A = 0$ °C | | -5.5 | ±0.9 | +5.5 | | |
| Temperature Sensor Error (Note 1) | | T _A = +25°C | | -3.0 | ±0.8 | +3.0 | °C | |
| (11010-1) | | T _A = +85°C | | -4.5 | ±0.5 | +4.5 | | |
| | | T _A = +125°C | | -5.0 | ±0.5 | +5.0 | | |
| | t _{D1} | | V_{TS1} = GND, V_{TS0} = GND | | 5T | | | |
| Output Pulse Delay | t _{D2} | MAX6575L, T (temp) in °K, | V_{TS1} = GND, V_{TS0} = V_{DD} | | 20T | | - - µs | |
| | t _{D3} | Figure 1 | $V_{TS1} = V_{DD}, V_{TS0} = GND$ | | 40T | | | |
| | t _{D4} | l iguio i | $V_{TS1} = V_{DD}, V_{TS0} = V_{DD}$ | | 80T | | | |
| | t _{D5} | MAX6575H, T (temp) in °K, Figure 1 | V _{TS1} = GND, V _{TS0} = GND | | 160T | | | |
| | t _{D6} | | V_{TS1} = GND, V_{TS0} = V_{DD} | | 320T | | | |
| | t _{D7} | | $V_{TS1} = V_{DD}, V_{TS0} = GND$ | | 480T | | | |
| | t _{D8} | | $V_{TS1} = V_{DD}, V_{TS0} = V_{DD}$ | | 640T | | | |
| Output Pulse Low Time | t _{L1-8} | Figure 1 | | | 5T | | μs | |
| Reset Pulse Width (Note 2) | t _{RESET} | Figure 1 | | 4.6 | | 16.0 | ms | |
| Setup Time | t _{SETUP} | Figure 1 | | | 10 | | μs | |
| Start Pulse (Note 3) | t _{START} | Figure 1, T _A = + | 25°C | 2.5 | | | μs | |
| Delay Time from Trigger to Ready (Note 4) | t _{READY} | Figure 1 | | | | 520 | ms | |
| Glitch Immunity on I/O Input | | | | | 500 | | ns | |
| Time Calant Dia Lania Lavala | V _{IL} | | | | | 0.8 | | |
| Time-Select Pin Logic Levels | V _{IH} | | | 2.3 | | | V | |
| | | V _{DD} > 4.5V, I _{SINK} = 3.2mA | | | | 0.4 | | |
| I/O Output Voltage Low | V _{OL} | V _{DD} > 2.7V, I _{SIN} | V _{DD} > 2.7V, I _{SINK} = 1.2mA | | | 0.3 | V | |
| I/O Input Voltage Low | V _{IL} | | | | | 0.8 | V | |
| I/O Input Voltage High | V _{IH} | | | 2.3 | | | V | |

Note 1: See Temperature Accuracy histograms in Typical Operating Characteristics.

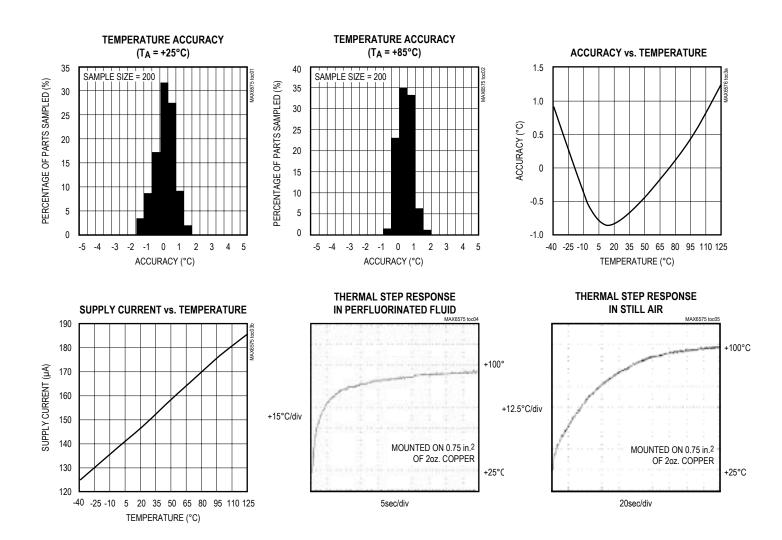
Note 2: Guaranteed by design. Not production tested.

Note 3: Limit maximum start pulse at 1ms to avoid timing overlap.

Note 4: If no reset pulse is applied.

Typical Operating Characteristics

 $(V_{DD} = +5V, T_A = +25^{\circ}C, unless otherwise noted.)$



Pin Configuration

| PIN | NAME | FUNCTION |
|------|----------|--|
| 1 | V_{DD} | Positive Supply Voltage |
| 2 | GND | Ground |
| 3 | N.C. | No Connect. Connect pin to GND or leave open. |
| 4, 5 | TS0, TS1 | Time-Select Pins. Set the time delay factor by connecting TS1 and TS0 to either V _{DD} or GND. See Table 1. |
| 6 | I/O | Bidirectional Interface Pin. A time delay between when the part is initiated externally by pulling I/O low and when the part subsequently pulls I/O low, is proportional to absolute temperature (°K). |

Detailed Description

The MAX6575L/H low-cost, low-current (150 μ A typ) temperature sensor is ideal for interfacing with microcon trollers or microprocessors. The MAX6575L/H is a monostable, externally triggered temperature sensor that uses a Temp—Delay conversion to communicate with a μ P over a single I/O line. Time-select pins (TS1, TS0) permit the internal temperature-controlled oscillator (TCO) to be scaled by four preset timeout multipliers, allowing eight separate temperature sensors to share one I/O line. Different sensors on the same I/O line will use different timeout multipliers to avoid overlapping signals.

Operating the MAX6575L/H

Figure 1 illustrates the timing for the MAX6575L/H. When the device is powered up, it assumes a ready state where it awaits an external trigger at the I/O pin. The I/O pin of the MAX6575L/H has an open-drain output structure that requires a pullup resistor to maintain the proper logic levels. Once the I/O pin is pulled low and then released. control of the I/O pin is transferred to the MAX6575L/H. The temperature conversion begins on the falling edge of the externally triggered pulse. The I/O line is pulled low at a later time. That time is determined by the device temperature and the Time Select pins (TS1, TS0). The I/O line remains low for 5Tµs, where T is the temperature in degrees Kelvin. The temperature of the device is represented by the edgeto-edge delay of the externally triggered pulse and the falling edge of the subsequent pulse originating from the device. The device can be manually reset by pulling the I/O line low for more than tRESET (16ms max). The device will automatically reset after a

Table 1. Time-Select Pin Configuration

| TIME-SEL | ECT PINS | TIMEOUT MULTIPLIERS (µs/°K) | | |
|-----------------|----------|-----------------------------|----------|--|
| TS1 | TS0 | MAX6575L | MAX6575H | |
| GND | GND | 5 | 160 | |
| GND | V_{DD} | 20 | 320 | |
| V _{DD} | GND | 40 | 480 | |
| V _{DD} | V_{DD} | 80 | 640 | |

maximum delay of 520ms, at which point it will again be in a ready state awaiting a start pulse.

Definition of Terms:

t_{RESET}: Time I/O must be externally pulled low to guarantee the MAX6575L/H is in a ready state awaiting external trigger. (Part will assume a ready state after 520ms without a reset pulse.)

t_{SETUP}: Time I/O must be high prior to a start pulse.

t_{START}: Trigger pulse which starts the on-chip timing sequence on its falling edge.

t_{Dx}: Timing delay between the falling edge of the start pulse and the falling edge initiated by CHIP#x.

 $t_{Lx:}$ I/O pulse low time (5Tµs).

t_{READY}: Time after falling edge of start pulse when the MAX6575L/H will reset itself and await the next external trigger.

The temperature, in degrees Celsius, may be calculated as follows:

 $T(^{\circ}C) = [t_{Dx(\mu s)} / timeout multiplier(\mu s/^{\circ}K)] - 273.15^{\circ}K$

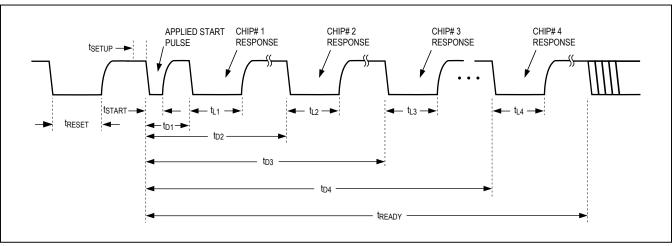


Figure 1. Timing Diagram

Table 2. Allowable Temperature Differential (°C)

| TIMEOUT | | MAX | 6575L | | | MAX | 6575H | |
|------------|---|------|-------|-------|-------|------|-------|------|
| MULTIPLIER | 5 | 20 | 40 | 80 | 160 | 320 | 480 | 640 |
| 5 | | >165 | >165 | >165 | >165 | >165 | >165 | >165 |
| 20 | | | 95.5 | >165 | >165 | >165 | >165 | >165 |
| 40 | | | | 132.0 | >165 | >165 | >165 | >165 |
| 80 | | | | | 153.5 | >165 | >165 | >165 |
| 160 | | | | | | >165 | >165 | >165 |
| 320 | | | | | | | 70.2 | >165 |
| 480 | | | | | | | | 37.9 |
| 640 | | | | | | | | |

Table 3. Typical Peak Noise Amplitude

| PARAMETER | MAX6575L | | | | | MAX | 5575H | |
|----------------------------|----------|-------|-------|--------|--------|--------|--------|--------|
| Timeout Multiplier | 5 | 20 | 40 | 80 | 160 | 320 | 480 | 640 |
| Noise Amplitude (°C) | ±0.33 | ±0.15 | ±0.15 | ±0.098 | ±0.091 | ±0.063 | ±0.043 | ±0.037 |

Time-Select Pins (TS1, TS0)

Table 1 shows the configuration of the Time-select pins for the MAX6575L/H. Each device allows four selectable timeout multipliers intended to prevent overlapping when multiple devices are used on the same I/O line. Tie TS1 and TS0 to either GND or V_{DD} to select the desired temperature multiplier.

To monitor several chips on the same I/O line, different timeout multipliers should be selected using the TS1 and TS0 pins. The timeout periods are then scaled so that the response times will not overlap (see *Timeout Selection*).

Applications Information

Timeout Selection

Under extreme temperature conditions, it is possible for an overlap to occur between the timeout delays of different sensors in a multidrop configuration. This overlap can occur only if the temperature differential recorded between two devices is very large. Timeout overlaps can be avoided in multidrop configurations by selecting the appropriate timeout multipliers. Table 2 illustrates the allowable temperature differential between devices when the maximum error is present on each device. Allowable temperature differentials greater than 165°C indicate no overlap.

For example, if the maximum temperature differential in a system is 80°C, the only combinations of timeout multipliers that could result in timeout overlap would be a 320:480µs/°K (70.2°C) or a 480:640µs/°K (37.9°C) combination. As long as these combinations of timeout multipliers are not used in the same multidrop configuration, no overlap can occur. Thus, seven MAX6575L/H parts can be used in the same multidrop configuration if the maximum temperature differential between parts is 80°C. A similar analysis shows that four MAX6575L/H parts can be used when the maximum temperature differential extends over the entire 165°C range of the part.

Noise Considerations

The accuracy of the MAX6575L/H timeout delay is susceptible to noise generated both internally and externally. The effects of external noise can be minimized by placing a 0.1µF ceramic bypass capacitor close to the device's supply pin. Internal noise is inherent in the operation of the device and is detailed in Table 3. Internal averaging minimizes the effect of this noise when using longer timeout multipliers. The effects of this noise are included in the overall accuracy of the device as specified in the Electrical Characteristics table.

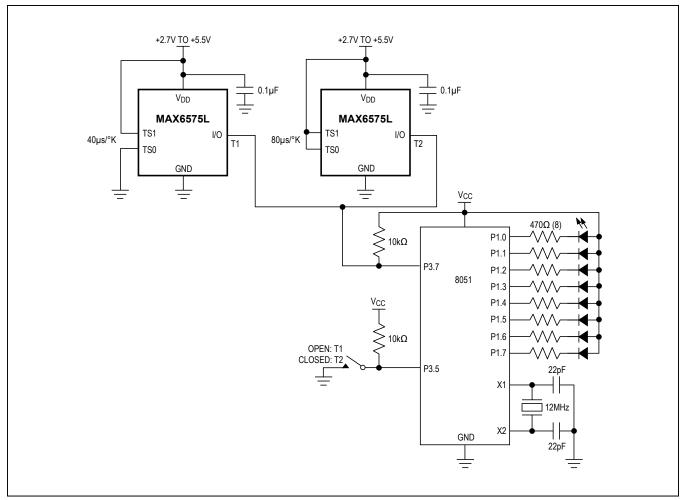


Figure 2. Interfacing Multiple Devices with a Microcontroller

Interfacing Multiple Devices with a Microcontroller

Figure 2 shows how to interface multiple MAX6575L/H devices with an 8051 microcontroller. The first device, T1, is configured for a timeout multiplier of $40\mu s$ /°K, while the second device, T2, is configured for a timeout multiplier of $80\mu s$ /°K to avoid overlap. The microcontroller takes in temperature values from both sensors, T1 and T2, on a single port pin, P3.7. The microcontroller displays five times the temperature in degrees Celsius in binary on Port 1. A switch connected to a pull-up resistor at Port 3.5 selects which temperature is displayed: open = T1, closed = T2. Code is provided for this application as Listing 1.

Listing 1. 8051 Code Example

```
; Demonstration and test code for MAX6575 Temp to Delay
; Takes in temperature values from 2 sensors on single
; port pin, P3.7 and displays temp as 5 times C in binary on
; port 1. port 3.5 selects which temp displayed- H=1, L=2.
; example: room temp= 21 C, display 105 or 01101001 on P1
; EQUATES
TEMP1H
           EQU 10H
                                   ;TEMPERATURE 1
                11H
TEMP1I.
           EQU
TEMP2H
           EQU
                 12H
                                   ;TEMPERATURE 2
TEMP2L
           EQU
D1
           EOU
                 30H
                                   ;delay scratch registers
D2
           EQU
                 31H
DЗ
            EQU
                 32H
;PINS
IOPIN
           BIT
                 P3.7
                                   ; single pin interface
SLCT
           BIT
                 P3.5
                                   ;select display 1/2= H/L
; MAIN
            ORG
                                   ;note one isr's used- timer overflow
            AJMP BEGIN
                                   ;jump over isr's
            ORG
                  0BH
                                   ;timer 0 overflow- error
            CLR
                 TF0
                                   ; clear timer overflow
            POP
                 ACC
                                   ;unstack return address
            POP
                 ACC
                                   ;unstack return address
            PUSH LOW (DOTMP)
                                  ;return to top on error
            PUSH HIGH (DOTMP)
                                  ;return to top on error
            CLR
                 TR0
                                   ;clear timer run
            RETI
                 30h
           org
BEGIN:
           MOV
                 SP.#70h
                                   ;set sp at 70H
;setup timer0 to do timing
           MOV
                 TMOD, #01H
                                   ;t0 timer 16 bit
           MOV
                 IE,#82H
                                   ;enable tf0 irg- error
;inits done- measure 2 temps
DOTMP:
           MOV
                 TH0,#0
                                   ;zero counter
                 TL0,#0
                                  ;zero counter
            SETB TRO
                                  start timer;
            CLR
                 IOPIN
                                  ;write pin low- start
            CALL DLYP1
                                   ;100 uS min low
            SETB IOPIN
                                   bring high
;do temp 1
           MOV
                 R0,#TEMP1H
                                   ;point at templ- high byte
            CALL GTTP
                                   ;get temp1
;do temp 2
           MOV
                 RO, #TEMP2H
                                   ;point at temp2- high byte
            CALL
                 GTTP
                                   ;get temp2
            CLR
                 TR0
                                   ;stop timer- acquistion done
```

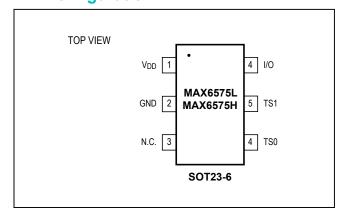
Listing 1. 8051 Code Example (continued)

```
; 2 temps are stored- display bin value of selected on P1
; temps are 40T,80T- times are in us
                                  ;get temp1- low byte (40T)
           VOM
                 RO, #TEMP1L
                 R4,#3 ;shift right 3x for 5x temp, div 8
           CALL TMTOC ; convert delay to degrees C x 5
                P3.5,DSP2 ;if select low, display temp2
           JNB
                                  get temperature
           MOV
                A, TEMP1L
           CPL
                 Α
                                 ;invert it for active low led's
           MOV
                 P1.A
                                 ; display this temp
                               get temp2- low byte (80T)
                 R0,#TEMP2L
DSP2:
           MOV
                 R4,#4 ;shift right 4x for 5x temp, div 16
TMTOC ;convert delay to degrees C x 5
P3.5,DSP1 ;if select high, display temp1 above
A,TEMP2L ;get temperature
           MOV
           CALL TMTOC
           JB
           MOV A, TEMP2L
           CPL
                A
                                 ;invert it for active low led's
           MOV
                 P1,A
                                  ;display this temp
; done
; wait for 600 ms and do it again
DSP1: MOV D3,#60
DLL1:
          MOV D2,#100
DLL2:
          MOV D1,#50
                                  ;inner loop
                                 ;100p 100 us
           DJNZ D1, DLLLP
DLLLP:
           DJNZ D2,DLL2
                                  ;loop 10 ms
           DJNZ D3,DLL1
                                  ;loop 600ms
                                  ;loop forever
           JMP DOTMP
;subroutines
,***********************
;GET TEMP- main, capture timer0 to @r0 after pin low edge
          JB IOPIN,GTTP ; wait for low- irq gets hangs
           MOV A, THO
                                  ;get high- quick
                                get low- quick
check rollover msb
           MOV B, TLO
           CJNE A, THO, ROLL
           JMP NOROL
                                  ; no
                                get high again;
ROLL:
           MOV
                 A, THO
           MOV B, TLO
                                ;get low again
;stash msb
           MOV @RO,A
INC RO
MOV @RO,B
NOROL:
                                 ;point next
                                 stash lsb;
                IOPIN, WAITH ; wait for low- irq gets hangs
:HTIAW
           JNB
           RET
; sub; converts uS to degrees c x 5, R4 is # of right shifts
TMTOC:
           CALL SHRO
                                  ;shift right
           DJNZ R4, TMTOC
                                  ;loop til shifted= 5x
           MOV
                A,@RO
                                 get x5 lsb;
           CLR
                C
                                 ;ready for subb
           SUBB A,#055H
                                 ;low byte of 273 x 5- offset
           MOV
                 @RO,A
                                  ;stash back
           DEC
                 R0
                                  point hi;
           MOV
                A,@RO
                                  ;get hi- prop carry
```

Listing 1. 8051 Code Example (continued)

```
SUBB A.#05H
                                     ; sub high of 273 x 5- offset
            MOV
                  @R0,A
                                     ;stash back- degrees c x 5 in temp
            RET
                                     :done
;shift right routine- "divide by 2" - point low on enter/exit
SHR0:
                                     ;point high
            MOV
                  A,@RO
                                     get high;
            CLR
                  С
                                     ;roll 0 into msbit
            RRC
                  A
                                    ;shift right
            MOV
                  @R0,A
                                     ;stash back
            INC
                                     ;point low
            MOV
                  A,@R0
                                     ;get low- prop carry
            RRC
                                     ;shift right
            MOV
                  @R0,A
                                     ;stash back
            RET
                                     ;pointing at 1sb on exit
;short delay- 100 uS
DLYP1:
            MOV D1,#50
                                     ;~100 uS
D1LP:
            DJNZ D1,D1LP
                                     ;delay- also entry
            RET
                                     ;return after .1 ms
            END
```

Pin Configuration



Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

| PACKAGE TYPE | PACKAGE CODE | OUTLINE NO. | LAND PATTERN NO. |
|-----------------|-----------------|----------------|------------------------|
| 6 SOT23 | U6-4 | 21-0058 | 90-0175 |

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Revision History

| REVISION NUMBER | REVISION DATE | DESCRIPTION | PAGES CHANGED |
|--------------------|------------------|--|------------------|
| 0 | 4/99 | Initial release | _ |
| 1 | 11/14 | Removed automotive reference from data sheet | 1 |

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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